

FORM PTO-1449  
(REV. 7-80)U.S. DEPARTMENT OF COMMERCE  
PATENT AND TRADEMARK OFFICEATTY. DOCKET NO.  
501082.10 (98-0616.09)APPLICATION NO.  
09/652,714

**INFORMATION DISCLOSURE STATEMENT**

JAN 24 2002

(Use several sheets if necessary)

APPLICANT(S)  
Vishnu K. AgarwalFILING DATE  
August 31, 2000GROUP ART UNIT  
2815

## U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
<i>AA</i>	AA	3,649,886	03/14/72	Kooi	317	235	
<i>AB</i>	AB	4,717,602	01/05/88	Yamazaki	427	53.1	
<i>AC</i>	AC	5,232,871	08/03/93	Ho	437	190	
<i>AD</i>	AD	5,552,339	09/03/96	Hsieh	437	190	
<i>AE</i>	AE	5,733,816	03/31/98	Iyer et al.	438	592	
<i>AF</i>	AF	6,136,690	10/24/00	Li	438	627	
<i>AG</i>	AG	6,153,519	11/28/00	Jain et al.	438	681	
<i>AH</i>	AH	6,204,203	03/20/01	Narwankar et al.	438	785	
<i>AI</i>	AI	6,245,662	06/12/01	Naik et al.	438	622	

## FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
<i>AJ</i>	AJ	355011329 A	01/26/80	JP (Abstract only)			X	
<i>AK</i>	AK	410070091 A	03/10/98	JP (Abstract only)			X	

## OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)

<i>AL</i>	AL	Anonymous, "Oxide-Free Dielectric/GaAs Interface With No Excess As", IBM Technical Disclosure Bulletin, Vol. 33, No. 11, April 1, 1991, p. 352.						
<i>AM</i>	AM	Schulz, S.E. et al., "Influence of Water Preclean Before Selective Tungsten CVD on Surface Properties of Interconnect and Intermetal Dielectric Materials", Physica Status Solidi A, Vol. 145, No. 2, October 16, 1994, pp. 311-318.						

EXAMINER

DATE CONSIDERED

4/25/02

\* EXAMINER: Initial if reference considered, whether or not criteria is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).

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## U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
AA		6,255,688 B1	07/03/01	Lee et al.	257	311	
AB		6,281,542 B1	08/28/01	Wu	257	308	
AC		6,320,213 B1	11/20/01	Kirlin et al.	257	295	
AD							
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<i>AA</i>	AA	5,552,341	09/03/96	Lee	437	192	
<i>AB</i>	AB	5,843,843	12/01/98	Lee et al.	438	688	
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	AH						
	AI						
	AJ						

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